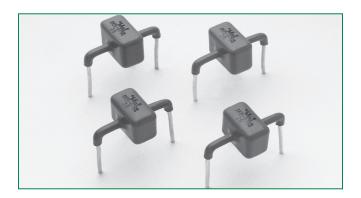


AK15 Series









Description

The AK15 series of high current transient suppressors have been specially designed for use in A.C. line protection and any demanding applications (AC or DC). They offer superior clamping characteristics over standard S.A.D. technologies by virtue of the Littelfuse foldbak technology, which provides a clamping voltage lower than the avalanche voltage (but above the rated working voltage). Therefore, any voltage rise due to increased current conduction is contained to a minimum, providing the best possible protection level. They can also be connected in series and/ or parallel to create very high capacity protection solutions.

Agency Approvals

AGENCY	AGENCY FILE NUMBER	
₽	E128662	

Maximum Ratings and Thermal Characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Storage Temperature Range	T _{STG}	(-)55 to 125	°C
Operating Junction Temperature Range	TJ	(-)55 to 125	°C
Current Rating ¹	I _{PP}	15	kA

Features

- Very low clamping voltage
- •Ultra compact: Less than one-tenth the size of traditional discrete solutions
- Sharp breakdown voltage
- Low slope resistance

- Bi-directional
- Foldbak technology for superior clamping factor
- Halogen-free
- RoHS compliant
- Glass passivated junction

1. Rated I_{pp} measured with 8 x 20µs pulse.

Electrical Characteristics

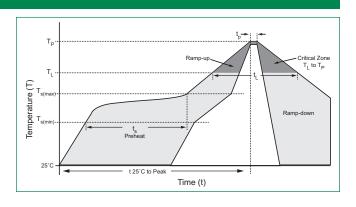
Part Numbers	Standoff Voltage (V _{SO}) Volts	Reverse Leakage	Voltage (reakdown (V _{BR}) @ I _T	l _t	Max. Clamp V _{CL} @ Peak P (I _{PP}) (N	ulse Current		Max. Capacitance 0 Bias 10kHz	
	Volts	(I _R) @V _{so} μΑ	Min Volts	Max Volts	(mA)	V _{CL} Volts	I _{PP} Amps	(%/ºC)	(nF)	8/6
AK15 - 058C	58	20	64	70	10	110	15,000	0.1	12	X
AK15 - 066C	66	20	72	80	10	120	15,000	0.1	10	Χ
AK15 - 076C	76	20	85	95	10	150	15,000	0.1	10	X

Note: Using 8 x $20\mu S$ wave shaped defined in IEC 61000-4-5.

Transient Voltage Suppression DiodesAxial Leaded – 15kA > AK15 series

Soldering Parameters

Reflow Co	ndition	Lead-free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 180 secs
Average ra	amp up rate (LiquidusTemp k	3°C/second max
T _{S(max)} to T _L	- Ramp-up Rate	3°C/second max
Reflow	-Temperature (T _L) (Liquidus)	217°C
Retiow	-Time (min to max) (t _s)	60 – 150 seconds
PeakTemp	erature (T _P)	260 ^{+0/-5} °C
Time with	in 5°C of actual peak ure (t _p)	20 - 40 seconds
Ramp-dov	vn Rate	6°C/second max
Time 25°C	to peakTemperature (T _P)	8 minutes Max.
Do not exc	ceed	280°C



Flow/Wave Soldering (Solder Dipping)

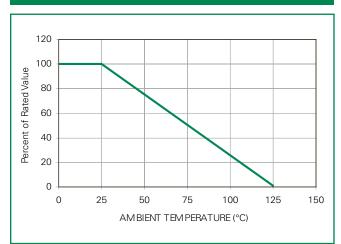
Peak Temperature :	265°C
Dipping Time :	10 seconds
Soldering :	1 time

Physical Specifications

Weight	Contact manufacturer
Case	Epoxy encapsulated
Terminal	Silver plated leads, solderable per MIL-STD-202 Method 208

Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Peak Power Derating

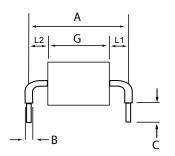


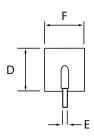


Transient Voltage Suppression Diodes

Axial Leaded – 15kA > AK15 series

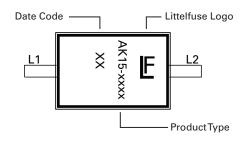
Dimensions





Dimensions	Inches	Millimeters	
А	0.95±0.03	24.15±0.8	
В	0.095±0.024	2.4±0.60	
С	0.236±0.04	6.00±1.0	
D	0.630±0.055	16.0±1.4	
E	0.050±0.002	1.27±0.05	
F	0.571±0.055	14.5±1.4	
G - 058C	0.292±0.047	7.41±1.20	
G - 066C/076C	0.351±0.047	8.91±1.20	
L1	0.310±0.047	7.87±1.20	
L2	L2= A - (G +L1), Tolerance ±0.047	L2= A - (G +L1), Tolerance ±1.20	

Part Marking System



Part Numbering System

